

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Title::	Method and System for Analyzing Defects of an Integrated Circuit Wafer
Attorney Docket Number::	MXIC 1555-1
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	Fig. 3
Total Drawing Sheets::	5
Small Entity?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Republic of China
Status::	Full Capacity
Given Name::	Shu-Sing
Family Name::	Liao
City of Residence::	Taichung City
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Country of Residence::	Republic of China
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City of mailing address::	Taichung City 408
State or Province of mailing address::	Taiwan
Country of mailing address::	Republic of China

Applicant Authority Type:: Inventor
 Primary Citizenship Country:: Republic of China
 Status:: Full Capacity
 Given Name:: Szu-Tsun
 Family Name:: Ma
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 Country of mailing address:: Republic of China

Correspondence Information

Correspondence Customer Number:: 22470

Representative Information

Representative Customer Number::	22470	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::

Assignee Information

Assignee name:: Macronix International Co., Ltd.
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State or Province of mailing address:: Taiwan
Country of mailing address:: Republic of China